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SN74AVC16T245

SCES551E - FEBRUARY 2004-REVISED NOVEMBER 2015

Support &

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SN74AVC16T245 16-Bit Dual-Supply Bus Transceiver with Configurable Level-Shifting / Voltage Translation and Tri-State Outputs

Technical

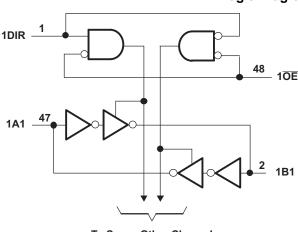
Documents

1 Features

- Control Inputs $V_{\text{IH}}/V_{\text{IL}}$ Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- Overvoltage-Tolerant Inputs and Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2 V to 3.6 V Power-Supply Range
- Ioff Supports Partial-Power-Down Mode Operation
- I/Os Are 4.6 V Tolerant
- Maximum Data Rates
 - 380 Mbps (1.8 V to 3.3 V Level-Shifting)
 - 200 Mbps (<1.8 V to 3.3 V Level-Shifting)
 - 200 Mbps (Level-Shifting to 2.5 V or 1.8 V)
 - 150 Mbps (Level-Shifting to 1.5 V)
 - 100 Mbps (Level-Shifting to 1.2 V)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

2 Applications

- Personal Electronics
- Industrial
- Enterprise
- Telecom



To Seven Other Channels

3 Description

Tools &

Software

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The SN74AVC16T245 device is optimized to operate with V_{CCA}/V_{CCB} set at 1.4 V to 3.6 V. The device is operational with V_{CCA}/V_{CCB} as low as 1.2 V. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVC16T245 device is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the outputs so the buses effectively are isolated.

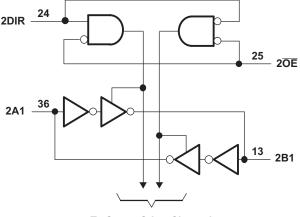
The SN74AVC16T245 control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V_{CCA} .

Device Information⁽¹⁾

| PART NUMBER | PACKAGE | BODY SIZE (NOM) | | |
|---------------|------------------------------|--------------------|--|--|
| | TSSOP (48) | 12.50 mm × 6.10 mm | | |
| SN74AVC16T245 | TVSOP (48) | 9.70 mm × 4.40 mm | | |
| | BGA MICROSTAR JUNIOR (56) | 7.00 mm × 4.50 mm | | |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Logic Diagram (Positive Logic)



To Seven Other Channels

TEXAS INSTRUMENTS

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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| CI | hanges from Revision D (February 2015) to Revision E | Page |
|----|--|------|
| • | Updated Pin Functions Table. | 4 |
| | | |

Changes from Revision C (August 2005) to Revision D

 Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section

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5 Description (continued)

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

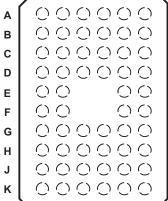
The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CCA} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



6 Pin Configuration and Functions

GQL or ZQL Package 56-Pin BGA MICROSTAR JUNIOR Top View 1 2 3 4 5 6



| DGG 48-Pin | | / Package P or TVSOI /iew | P |
|---------------|---|---------------------------------|---|
| | 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 | P or TVSO | |
| 2B5 [| 19 | 30 2A5 | |
| 2B6 🛛 | 20 | 29 2A6 | ; |
| GND | 21 | 28 GNI | |
| 2B7 | 22 | 27 2A7 | |
| | 23 24 | 26 2A8 | - |
| 2DIR [| 24 | 25 2 0 E | = |

Pin Functions

| | PIN | | | | | | | |
|---------------------------|-----------------------------------|-----------------------------------|-----|--|--|--|--|--|
| NAME | TSSOP, TVSOP | BGA MICROSTAR | I/O | DESCRIPTION | | | | |
| 1DIR, 2DIR | 1, 24 | A1, K1 | Ι | Direction-control signal | | | | |
| 1B1 to 1B8 | 2, 3, 5, 6, 8, 9, 11, 12 | B2, B1, C2, C1, D2, D1, E2, E1 | I/O | Input/Output. Referenced to V _{CCB} | | | | |
| 2B1 to 2B8 | 13, 14, 16, 17, 19, 20, 22, 23 | F1, F2, G1, G2, H1, H2, J1, J2 | I/O | Input/Output. Referenced to V _{CCB} | | | | |
| GND | 4, 10, 15, 21, 45, 39, 34, 28 | B3, D3, G3, J3, J4, G4, D4, B4 | | Ground | | | | |
| V _{CCB} | 7, 18 | C3, H3 | | B-port supply voltage. 1.2 V \leq V _{CCB} \leq 3.6 V | | | | |
| 1 <u>0E</u> , 2 <u>0E</u> | 48, 25 | A6, K6 | — | Tri-State output-mode enables. Pull \overline{OE} high to place all outputs in Tri-State mode. Referenced to V_{CCA} | | | | |
| 1A1 to 1A8 | 47, 46, 44, 43, 41, 40, 38, 37 | B5, B6, C5, C6, D5, D6, E5, E6 | I/O | Input/Output. Referenced to V _{CCA} | | | | |
| 2A1 to 2A8 | 36, 35, 33, 32, 30, 29, 27, 26 | F6, F5, G6, G5, H6, H5, J6, J5 | I/O | Input/Output. Referenced to V _{CCA} | | | | |
| V _{CCA} | 42, 31 | C4, H4 | _ | A-port supply voltage. 1.2 V \leq V _{CCB} \leq 3.6 V | | | | |
| N.C. | _ | A2, A3, A4, A5, K2, K3, K4, K5 | _ | No internal connection | | | | |



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7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | | MIN | MAX | UNIT | |
|--------------------------------------|--|--------------------|------|------------------------|------|--|
| V _{CCA} V _{CCB} | Supply voltage | | -0.5 | 4.6 | V | |
| | | I/O ports (A port) | -0.5 | 4.6 | | |
| VI | Input voltage ⁽²⁾ | I/O ports (B port) | -0.5 | 4.6 | V | |
| | | Control inputs | -0.5 | 4.6 | | |
| V | Voltage range applied to any output in the high-impedance or power- | A port | -0.5 | 4.6 | v | |
| Vo | off state ⁽²⁾ | B port | -0.5 | 4.6 | V | |
| V | Vales a respect of the end of the set of the birth of law state $\binom{2}{3}$ | A port | -0.5 | V _{CCA} + 0.5 | v | |
| Vo | Voltage range applied to any output in the high or low state $^{(2)(3)}$ | B port | -0.5 | V _{CCB} + 0.5 | v | |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA | |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA | |
| I _O | Continuous output current | | | ±50 | mA | |
| | Continuous current through each V_{CCA} , V_{CCB} , and GND | | | ±100 | mA | |
| | | DGG package | | 70 | | |
| $R_{\theta J A}$ | Package thermal impedance ⁽⁴⁾ | DGV package | | 58 | °C/W | |
| | | GQL/ZQL package | | 42 | | |
| TJ | Junction temperature | | -40 | 150 | °C | |
| T _{stg} | Storage temperature | | -65 | 150 | °C | |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input voltage (V_I) and output negative-voltage (V_O) ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

7.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| | | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | ±8000 | |
| V _(ESD) | Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | ±1000 | V |
| | | Machine model (A115-A) | ±200 | |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 500-V HBM is possible with the necessary precautions.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250-V CDM is possible with the necessary precautions.

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7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)⁽¹⁾⁽²⁾⁽³⁾

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------------------------|---|-----------------------------------|------------------|------------------|-------------------------|-----------------------|------|
| V _{CCA} | Supply voltage | | | | 1.2 | 3.6 | V |
| V _{CCB} | Supply voltage | | | | 1.2 | 3.6 | V |
| | | | 1.2 V to 1.95 V | | V _{CCI} × 0.65 | | |
| VIH | High-level input voltage | Data inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCI} \times 0.35$ | |
| VIL | Low-level input voltage | Data inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | | 0.7 | V |
| | input voltage | | 2.7 V to 3.6 V | | | 0.8 | |
| | | DIR | 1.2 V to 1.95 V | | $V_{CCA} \times 0.65$ | | |
| VIH | High-level | (referenced to | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | V _{CCA}) ⁽⁵⁾ | 2.7 V to 3.6 V | | 2 | | |
| | | DIR | 1.2 V to 1.95 V | | | $V_{CCA} \times 0.35$ | |
| VIL | / _{IL} Low-level IL input voltage | (referenced to | 1.95 V to 2.7 V | | | 0.7 | V |
| | | V _{CCA}) ⁽⁵⁾ | 2.7 V to 3.6 V | | | 0.8 | |
| VI | Input voltage | | | | 0 | 3.6 | V |
| ., | | Active state | | | 0 | V _{cco} | |
| Vo | Output voltage | Tri-State | | | 0 | 3.6 | V |
| | | | | 1.2 V | | -3 | |
| | | | | 1.4 V to 1.6 V | | -6 | |
| I _{OH} | High-level output | current | | 1.65 V to 1.95 V | | -8 | mA |
| | | | | 2.3 V to 2.7 V | | -9 | |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.2 V | | 3 | |
| I _{OL} Low-level output c | | | | 1.4 V to 1.6 V | | 6 | |
| | | current | | 1.65 V to 1.95 V | | 8 | mA |
| | | | | 2.3 V to 2.7 V | | 9 | |
| | | | | 3 V to 3.6 V | | 12 | |
| Δt/Δv | Input transition ris | se or fall rate | | | | 5 | ns/V |
| T _A | Operating free-air | r temperature | | | -40 | 85 | °C |

V_{CCI} is the V_{CC} associated with the data input port.
V_{CCO} is the V_{CC} associated with the output port.
All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, SCBA004.
For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.
For V_{CCA} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.

7.4 Thermal Information

| | | | SN74 | AVC16T245 | |
|----------------------|--|----------------|----------------|-------------------------------|------|
| | THERMAL METRIC ⁽¹⁾ | DGV (TVSOP) | DGG (TSSOP) | ZQL (BGA MICROSTAR JUNIOR) | UNIT |
| | | 48 PINS | 48 PINS | 56 PINS | |
| $R_{\theta J A}$ | Junction-to-ambient thermal resistance | 82.5 | 69.9 | 64.6 | °C/W |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance | 34.2 | 23.9 | 16.6 | °C/W |
| $R_{\theta J B}$ | Junction-to-board thermal resistance | 45.1 | 36.6 | 30.8 | °C/W |
| ΨJT | Junction-to-top characterization parameter | 2.7 | 1.7 | 0.9 | °C/W |
| ψ_{JB} | Junction-to-board characterization parameter | 44.6 | 36.2 | 64.6 | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



7.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) $^{(1)(2)}$

| | | TEST CON | | | v | T, | ₄ = 25°C | | $T_A = -40^\circ$ | C to 85°C | | | |
|--------------------------------|-------------------------|---|------------------|------------------|------------------|-----|----------|-------|------------------------|-----------|-----|------|--|
| PAR | RAMETER | TEST CONI | DITIONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | TYP | MAX | UNIT | |
| | | I _{OH} = -100 μA | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | V _{CCO} - 0.2 | | | | |
| | | I _{OH} = -3 mA | | 1.2 V | 1.2 V | | 0.95 | | | | | | |
| ., | | I _{OH} = -6 mA | | 1.4 V | 1.4 V | | | | 1.05 | | | v | |
| V _{OH} | | I _{OH} = -8 mA | $V_{I} = V_{IH}$ | 1.65 V | 1.65 V | | | | 1.2 | | | v | |
| /oL | I _{OH} = -9 mA | | 2.3 V | 2.3 V | | | | 1.75 | | | | | |
| | | I _{OH} = -12 mA | | 3 V | 3 V | | | | 2.3 | | | | |
| | | I _{OL} = 100 μA | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | | 0.2 | | |
| | | I _{OL} = 3 mA | | 1.2 V | 1.2 V | | 0.15 | | | | | | |
| V _{OL} | $I_{OL} = 6 \text{ mA}$ | $V_I = V_{IL}$ | 1.4 V | 1.4 V | | | | | | 0.35 | v | | |
| | I _{OL} = 8 mA | $v_{I} = v_{IL}$ | 1.65 V | 1.65 V | | | | | | 0.45 | V | | |
| | I _{OL} = 9 mA | | 2.3 V | 2.3 V | | | | | | 0.55 | | | |
| | | I _{OL} = 12 mA | | 3 V | 3 V | | | | | | 0.7 | | |
| I, | Control inputs | $V_{I} = V_{CCA}$ or GN | D | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | ±0.025 | ±0.25 | | | | μA | |
| 1 | A or B port | | 6.)/ | 0 V | 0 to 3.6 V | | ±0.1 | ±2.5 | | | ±5 | | |
| l _{off} | A or B port | $V_{I} \text{ or } V_{O} = 0 \text{ to } 3$ | .0 V | 0 to 3.6 V | 0 V | | ±0.5 | ±2.5 | | | ±5 | μA | |
| I _{OZ} ⁽³⁾ | A or B port | $V_{O} = V_{CCO} \text{ or GN}$ $V_{I} = V_{CCI} \text{ or GNI}$ $\overline{OE} = V_{IH}$ | ND, D, | 3.6 V | 3.6 V | | ±0.5 | ±2.5 | | | ±5 | μA | |
| | | | _ | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | | 25 | | |
| I _{CCA} | | $V_{I} = V_{CCI}$ or GNI $I_{O} = 0$ | О, | 0 V | 3.6 V | | | | | | -5 | μA | |
| | | 1 ₀ = 0 | | 3.6 V | 0 V | | | | | | 25 | | |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | | 25 | | |
| I _{CCB} | | $V_I = V_{CCI}$ or GNI $I_O = 0$ | О, | 0 V | 3.6 V | | | | | | 25 | μA | |
| | | 0-0 | | 3.6 V | 0 V | | | | | | -5 | | |
| _{CCA} + | I _{CCB} | $V_{I} = V_{CCI}$ or GNI $I_{O} = 0$ | D, | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | | 45 | μA | |
| Ci | Control inputs | V _I = 3.3 V or GN | ID | 3.3 V | 3.3 V | | 3.5 | | | | | pF | |
| C _{io} | A or B port | $V_0 = 3.3 \text{ V or GI}$ | ND | 3.3 V | 3.3 V | | 7 | | | | | pF | |

 $\begin{array}{ll} (1) & V_{CCO} \text{ is the } V_{CC} \text{ associated with the output port.} \\ (2) & V_{CCI} \text{ is the } V_{CC} \text{ associated with the input port.} \\ (3) & \text{For I/O ports, the parameter } I_{OZ} \text{ includes the input leakage current.} \end{array}$

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7.6 Switching Characteristics: V_{CCA} = 1.2 V

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see Figure 11)

| PARAMETER | FROM | то | V _{CCB} = 1.2 | 2 V | Va | ссв = 1.5 \ | / | Vc | _{св} = 1.8 V | | Vcc | _B = 2.5 \ | / | Vcc | св = 3.3 | v | UNIT |
|------------------|---------|----------|------------------------|-----|-----|-------------|-----|-----|-----------------------|-----|-----|----------------------|-----|-----|----------|-----|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| t _{PLH} | А | В | 4.1 | | | 3.3 | | | 3 | | | 2.8 | | | 3.2 | | |
| t _{PHL} | A | В | 4.1 | | | 3.3 | | | 3 | | | 2.8 | | | 3.2 | | ns |
| t _{PLH} | D | | 4.4 | | | 4 | | | 3.8 | | | 3.6 | | | 3.5 | | |
| t _{PHL} | B A | | 4.4 | | 4 | | 3.8 | | 3.6 | | | 3.5 | | ns | | | |
| t _{PZH} | ŌĒ | А | 6.4 | | | 6.4 | | | 6.4 | | | 6.4 | | | 6.4 | | ns |
| t _{PZL} | UE | A | 6.4 | | 6.4 | | 6.4 | | 6.4 | | | 6.4 | | 115 | | | |
| t _{PZH} | OE | В | 6 | | | 4.6 | | | 4 | | | 3.4 | | | 3.2 | | |
| t _{PZL} | UE | 0E B 6 | | | 4.6 | | 4 | | 3.4 | | | 3.2 | | | ns | | |
| t _{PHZ} | ŌE | | 6.6 | | | 6.6 | | | 6.6 | | | 6.6 | | | 6.8 | | |
| t _{PLZ} | UE | A | 6.6 | | | 6.6 | | | 6.6 | | | 6.6 | | | 6.8 | | ns |
| t _{PHZ} | ŌE | В | 6 | | | 4.9 | | | 4.9 | | | 4.2 | | | 5.3 | | 20 |
| t _{PLZ} | UE | P | 6 | | | 4.9 | | | 4.9 | | | 4.2 | | | 5.3 | | ns |

7.7 Switching Characteristics: $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 11)

| | FROM | то | V _{CCB} = 1.2 | v | V _{CCB} : | = 1.5 V ± (| 0.1 V | V _{CCB} = 1.8 | V ± 0.15 V | V _{CCB} = | 2.5 V ± 0.2 V | V _{CCB} = | : 3.3 V ± 0.3 V | |
|------------------|---------|----------|------------------------|-----|--------------------|-------------|-------|------------------------|------------|--------------------|---------------|--------------------|-----------------|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN TYP | MAX | MIN | ТҮР | MAX | MIN | TYP MAX | MIN | TYP MAX | MIN | ΤΥΡ ΜΑΧ | UNIT |
| t _{PLH} | А | в | 3.6 | | 0.5 | | 6.2 | 0.5 | 5.2 | 0.5 | 4.1 | 0.5 | 3.7 | ns |
| t _{PHL} | A | Б | 3.6 | | 0.5 | | 6.2 | 0.5 | 5.2 | 0.5 | 4.1 | 0.5 | 3.7 | 115 |
| t _{PLH} | в | А | 3.3 | | 0.5 | | 6.2 | 0.5 | 5.9 | 0.5 | 5.6 | 0.5 | 5.5 | ns |
| t _{PHL} | Б | A | 3.3 | | 0.5 | | 6.2 | 0.5 | 5.9 | 0.5 | 5.6 | 0.5 | 5.5 | |
| t _{PZH} | OE | А | 4.3 | | 1 | | 10.1 | 1 | 10.1 | 1 | 10.1 | 1 | 10.1 | ns |
| t _{PZL} | UE | A | 4.3 | | 1 | | 10.1 | 1 | 10.1 | 1 | 10.1 | 1 | 10.1 | 115 |
| t _{PZH} | OE | в | 5.6 | | 1 | | 10.1 | 0.5 | 8.1 | 0.5 | 5.9 | 0.5 | 5.2 | ns |
| t _{PZL} | UE | Б | 5.6 | | 1 | | 10.1 | 0.5 | 8.1 | 0.5 | 5.9 | 0.5 | 5.2 | 115 |
| t _{PHZ} | OE | А | 4.5 | | 1.5 | | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | 20 |
| t _{PLZ} | UE | A | 4.5 | | 1.5 | | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | 1.5 | 9.1 | ns |
| t _{PHZ} | OE | в | 5.5 | | 1.5 | | 8.7 | 1.5 | 7.5 | 1 | 6.5 | 1 | 6.3 | |
| t _{PLZ} | UE | D | 5.5 | | 1.5 | | 8.7 | 1.5 | 7.5 | 1 | 6.5 | 1 | 6.3 | ns |

7.8 Switching Characteristics: $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 11)

| PARAMETER | FROM | то | V _{CCB} | ₃ = 1.2 V | | V _{CCB} = | 1.5 V ± 0 | .1 V | V _{CCB} = | 1.8 V ± 0.4 | 15 V | V _{CCB} = 2 | 2.5 V ± 0 | .2 V | V _{CCB} = 3 | 3.3 V ± | 0.3 V | UNIT |
|------------------|---------|----------|------------------|----------------------|-----|--------------------|-----------|------|--------------------|-------------|------|----------------------|-----------|------|----------------------|---------|-------|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN | TYP | MAX | MIN | TYP | MAX | MIN | ТҮР | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| t _{PLH} | | В | | 3.4 | | 0.5 | | 5.9 | 0.5 | | 4.8 | 0.5 | | 3.7 | 0.5 | | 3.3 | |
| t _{PHL} | A | Б | | 3.4 | | 0.5 | | 5.9 | 0.5 | | 4.8 | 0.5 | | 3.7 | 0.5 | | 3.3 | ns |
| t _{PLH} | в | А | | 3 | | 0.5 | | 5.2 | 0.5 | | 4.8 | 0.5 | | 4.5 | 0.5 | | 4.4 | |
| t _{PHL} | В | A | | 3 | | 0.5 | | 5.2 | 0.5 | | 4.8 | 0.5 | | 4.5 | 0.5 | | 4.4 | ns |
| t _{PZH} | OE | А | | 3.4 | | 1 | | 7.8 | 1 | | 7.8 | 1 | | 7.8 | 1 | | 7.8 | |
| t _{PZL} | UE | A | | 3.4 | | 1 | | 7.8 | 1 | | 7.8 | 1 | | 7.8 | 1 | | 7.8 | ns |
| t _{PZH} | OE | В | | 5.4 | | 1 | | 9.2 | 0.5 | | 7.4 | 0.5 | | 5.3 | 0.5 | | 4.5 | |
| t _{PZL} | UE | В | | 5.4 | | 1 | | 9.2 | 0.5 | | 7.4 | 0.5 | | 5.3 | 0.5 | | 4.5 | ns |
| t _{PHZ} | OE | | | 4.2 | | 1.5 | | 7.7 | 1.5 | | 7.7 | 1.5 | | 7.7 | 1.5 | | 7.7 | |
| t _{PLZ} | ÛE | A | | 4.2 | | 1.5 | | 7.7 | 1.5 | | 7.7 | 1.5 | | 7.7 | 1.5 | | 7.7 | ns |
| t _{PHZ} | OE | В | | 5.2 | | 1.5 | | 8.4 | 1.5 | | 7.1 | 1 | | 5.9 | 1 | | 5.7 | |
| t _{PLZ} | UE | В | | 5.2 | | 1.5 | | 8.4 | 1.5 | | 7.1 | 1 | | 5.9 | 1 | | 5.7 | ns |



7.9 Switching Characteristics: $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 11)

| PARAMETER | FROM | то | Vc | _{св} = 1.2 | v | V _{CCB} = ² | 1.5 V ± 0.1 | V | V _{CCB} = | 1.8 V ± 0 | .15 V | V _{CCB} = 2 | 2.5 V ± 0 | .2 V | V _{CCB} = 3 | 3.3 V ± (| 0.3 V | UNIT |
|------------------|---------|----------|-----|---------------------|-----|---------------------------------|-------------|-----|--------------------|-----------|-------|----------------------|-----------|------|----------------------|-----------|-------|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| t _{PLH} | A | В | | 3.2 | | 0.5 | | 5.6 | 0.5 | | 4.5 | 0.5 | | 3.3 | 0.5 | | 2.8 | |
| t _{PHL} | A | В | | 3.2 | | 0.5 | | 5.6 | 0.5 | | 4.5 | 0.5 | | 3.3 | 0.5 | | 2.8 | ns |
| t _{PLH} | в | | | 2.6 | | 0.5 | | 4.1 | 0.5 | | 3.7 | 0.5 | | 3.3 | 0.5 | | 3.2 | |
| t _{PHL} | В | A | | 2.6 | | 0.5 | | 4.1 | 0.5 | | 3.7 | 0.5 | | 3.3 | 0.5 | | 3.2 | ns |
| t _{PZH} | OE | | | 2.5 | | 0.5 | | 5.3 | 0.5 | | 5.3 | 0.5 | | 5.3 | 0.5 | | 5.3 | |
| t _{PZL} | UE | A | | 2.5 | | 0.5 | | 5.3 | 0.5 | | 5.3 | 0.5 | | 5.3 | 0.5 | | 5.3 | ns |
| t _{PZH} | OE | В | | 5.2 | | 0.5 | | 9.4 | 0.5 | | 7.3 | 0.5 | | 5.1 | 0.5 | | 4.5 | |
| t _{PZL} | UE | В | | 5.2 | | 0.5 | | 9.4 | 0.5 | | 7.3 | 0.5 | | 5.1 | 0.5 | | 4.5 | ns |
| t _{PHZ} | OE | | | 3 | | 1 | | 6.1 | 1 | | 6.1 | 1 | | 6.1 | 1 | | 6.1 | |
| t _{PLZ} | UE | A | | 3 | | 1 | | 6.1 | 1 | | 6.1 | 1 | | 6.1 | 1 | | 6.1 | ns |
| t _{PHZ} | OE | В | | 5 | | 1 | | 7.9 | 1 | | 6.6 | 1 | | 6.1 | 1 | | 5.2 | 20 |
| t _{PLZ} | UE | В | | 5 | | 1 | | 7.9 | 1 | | 6.6 | 1 | | 6.1 | 1 | | 5.2 | ns |

7.10 Switching Characteristics: $V_{CCA} = 3.3 V \pm 0.3 V$

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 11)

| | FROM | то | V _{CCB} : | = 1.2 V | ' | V _{CCB} = | 1.5 V ± 0 | .1 V | V _{CCB} = 1 | .8 V ± 0.1 | 5 V | V _{CCB} = 2 | 2.5 V ± (| 0.2 V | V _{CCB} = 3 | 3.3 V ± | 0.3 V | |
|------------------|---------|----------|--------------------|---------|-----|--------------------|-----------|------|----------------------|------------|-----|----------------------|-----------|-------|----------------------|---------|-------|------|
| PARAMETER | (INPUT) | (OUTPUT) | MIN | ТҮР | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| t _{PLH} | A | в | | 3.2 | | 0.5 | | 5.5 | 0.5 | | 4.4 | 0.5 | | 3.2 | 0.5 | | 2.7 | |
| t _{PHL} | A | В | | 3.2 | | 0.5 | | 5.5 | 0.5 | | 4.4 | 0.5 | | 3.2 | 0.5 | | 2.7 | ns |
| t _{PLH} | в | А | | 2.8 | | 0.5 | | 3.7 | 0.5 | | 3.3 | 0.5 | | 2.8 | 0.5 | | 2.7 | ns |
| t _{PHL} | Б | ~ | | 2.8 | | 0.5 | | 3.7 | 0.5 | | 3.3 | 0.5 | | 2.8 | 0.5 | | 2.7 | 115 |
| t _{PZH} | OE | А | | 2.2 | | 0.5 | | 4.3 | 0.5 | | 4.2 | 0.5 | | 4.1 | 0.5 | | 4 | ns |
| t _{PZL} | 0E | A | | 2.2 | | 0.5 | | 4.3 | 0.5 | | 4.2 | 0.5 | | 4.1 | 0.5 | | 4 | 115 |
| t _{PZH} | OE | в | | 5.1 | | 0.5 | | 9.3 | 0.5 | | 7.2 | 0.5 | | 4.9 | 0.5 | | 4 | ns |
| t _{PZL} | UE | Б | | 5.1 | | 0.5 | | 9.3 | 0.5 | | 7.2 | 0.5 | | 4.9 | 0.5 | | 4 | 115 |
| t _{PHZ} | ŌĒ | А | | 3.4 | | 0.5 | | 5 | 0.5 | | 5 | 0.5 | | 5 | 0.5 | | 5 | ns |
| t _{PLZ} | UE | ~ | | 3.4 | | 0.5 | | 5 | 0.5 | | 5 | 0.5 | | 5 | 0.5 | | 5 | 115 |
| t _{PHZ} | OE | в | | 4.9 | | 1 | | 7.7 | 1 | | 6.5 | 1 | | 5.2 | 0.5 | | 5 | ns |
| t _{PLZ} | JE JE | 6 | | 4.9 | | 1 | | 7.7 | 1 | | 6.5 | 1 | | 5.2 | 0.5 | | 5 | 115 |

7.11 Operating Characteristics

 $T_A = 25^{\circ}C$

| | PARAMETE | .n | TEST | V _{CCA} = | V _{CCB} = | 1.2 V | V _{CCA} = | V _{CCB} = 1. | 5 V | V _{CCA} = | : V _{ссв} = 1 | .8 V | V _{CCA} | = V _{ссв} = | 2.5 V | V _{CCA} = 1 | V _{ссв} = 3 | 3.3 V | UNIT |
|---------------------------------|----------|------------------|------------------------------------|--------------------|--------------------|-------|--------------------|-----------------------|-----|--------------------|------------------------|------|------------------|----------------------|-------|----------------------|----------------------|-------|------|
| | PARAMETE | :к | CONDITIONS | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | UNIT |
| | A to B | Outputs enabled | | | 1 | | | 1 | | | 1 | | | 1 | | | 2 | | |
| C _{pdA} ⁽¹⁾ | AIUB | Outputs disabled | C _L = 0, f = 10 MHz, | | 1 | | | 1 | | | 1 | | | 1 | | | 1 | | pF |
| CpdA | B to A | Outputs enabled | $t_r = t_f = 1 \text{ ns}$ | | 13 | | | 13 | | | 14 | | | 15 | | | 16 | | μr |
| | BIOA | Outputs disabled | | | 1 | | | 1 | | | 1 | | | 1 | | | 1 | | |
| | A to B | Outputs enabled | | | 13 | | | 13 | | | 14 | | | 15 | | | 16 | | |
| C _{pdB} ⁽¹⁾ | AIUB | Outputs disabled | $C_{L} = 0,$ f = 10 MHz, | | 1 | | | 1 | | | 1 | | | 1 | | | 1 | | pF |
| ⊂ _{pdB} `′ | B to A | Outputs enabled | $t_r = t_f = 1 \text{ ns}$ | | 1 | | | 1 | | | 1 | | | 1 | | | 2 | | μr |
| | BIOA | Outputs disabled | | | 1 | | | 1 | | | 1 | | | 1 | | | 1 | | |

(1) Power dissipation capacitance per transceiver. Refer to the TI application report, CMOS Power Consumption and Cpd Calculation, SCAA035

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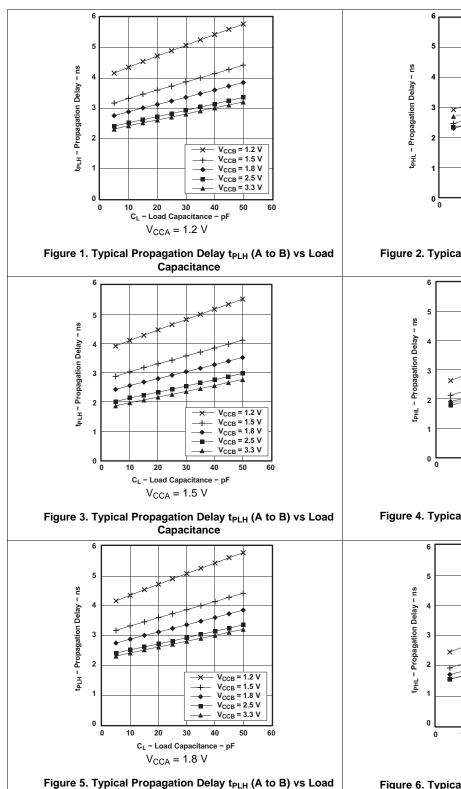
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7.12 Typical Characteristics

 $T_A = 25^{\circ}C$



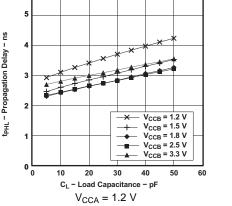


Figure 2. Typical Propagation Delay t_{PHL} (A to B) vs Load Capacitance

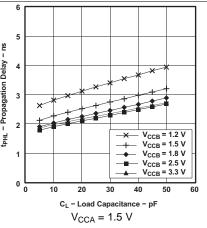
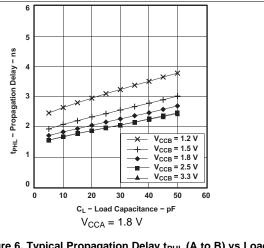


Figure 4. Typical Propagation Delay t_{PHL} (A to B) vs Load Capacitance



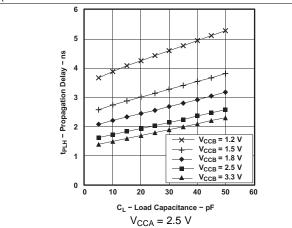


Capacitance

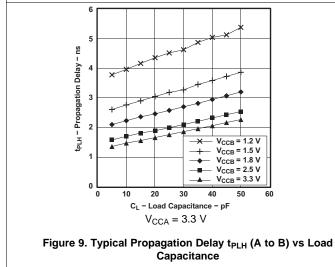


Typical Characteristics (continued)









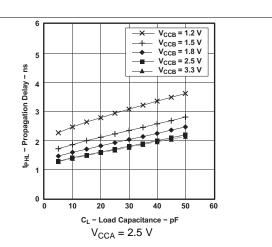
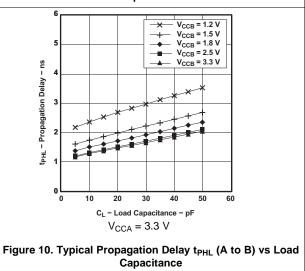


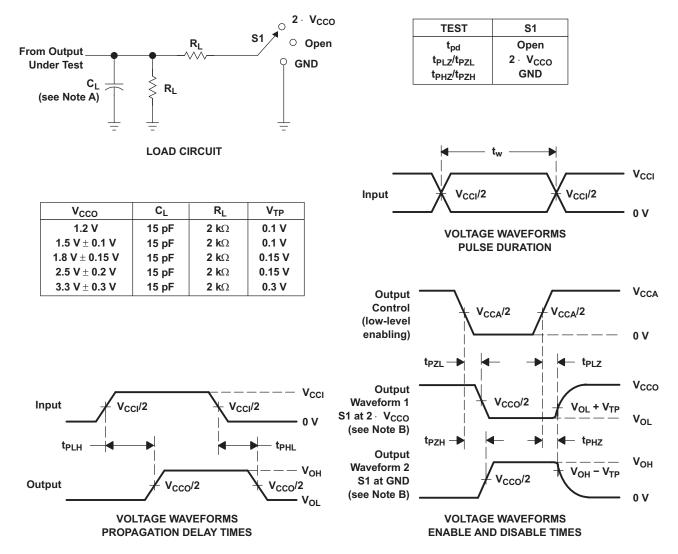
Figure 8. Typical Propagation Delay t_{PHL} (A to B) vs Load Capacitance



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8 Parameter Measurement Information



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR 10 MHz, $Z_0 = 50 \Omega$, dv/dt ≥ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLH} and t_{PHL} are the same as t_{pd} .
- F. V_{CCI} is the V_{CC} associated with the input port.
- G. V_{CCO} is the V_{CC} associated with the output port.

Figure 11. Load Circuit and Voltage Waveforms



9 Detailed Description

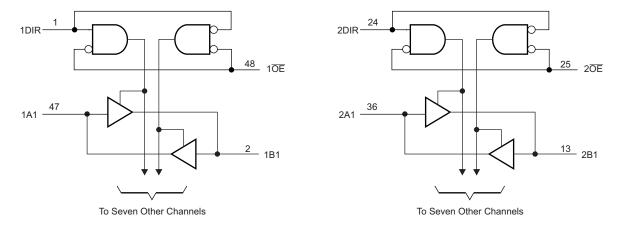
9.1 Overview

The SN74AVC16T245 is a 16-bit, dual-supply noninverting bidirectional voltage level translation. Pins A and control pins (DIR and OE) are supported by V_{CCA} and pins B are supported by V_{CCB} . The A port can accept I/O voltages ranging from 1.2 V to 3.6 V, while the B port can accept I/O voltages from 1.2 V to 3.6 V. A high on DIR allows data transmission from A to B and a low on DIR allows data transmission from B to A when OE is set to low. When OE is set to high, both A and B are in the high-impedance state.

This device is fully specified for partial-power-down applications using off output current (I_{off}).

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are put in a high-impedance state.

9.2 Functional Block Diagram



9.3 Feature Description

9.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range

Both V_{CCA} and V_{CCB} can be supplied at any voltage from 1.2 V to 3.6 V making the device suitable for translating between any of the low voltage nodes (1.2 V, 1.8 V, 2.5 V, and 3.3 V).

9.3.2 Partial-Power-Down Mode Operation

This device is fully specified for partial-power-down applications using off output current (I_{off}). The I_{off} circuitry will prevent backflow current by disabling I/O output circuits when device is in partial power-down mode.

9.3.3 V_{CC} Isolation

The V_{CC} isolation feature ensures that if either V_{CCA} or V_{CCB} are at GND, both ports will be in a high-impedance state (I_{OZ} shown in *Electrical Characteristics*). This prevents false logic levels from being presented to either bus.

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9.4 Device Functional Modes

The SN74AVC16T245 is a voltage level translator that can operate from 1.2 V to 3.6 V (V_{CCA}) and 1.2 V to 3.6 V (V_{CCB}). The signal translation between 1.2 V and 3.6 V requires direction control and output enable control. When OE is low and DIR is high, data transmission is from A to B. When OE is low and DIR is low, data transmission is from B to A. When OE is high, both output ports will be high-impedance.

| CONTROL | L INPUTS | OUTPUT C | IRCUITS | OPERATION |
|---------|----------|----------|---------|-----------------|
| OE | DIR | A PORT | B PORT | OPERATION |
| L | L | Enabled | Hi-Z | B data to A bus |
| L | Н | Hi-Z | Enabled | A data to B bus |
| Н | Х | Hi-Z | Hi-Z | Isolation |

Table 1. Functions Table⁽¹⁾

(1) Input circuits of the data I/Os always are active.



10 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

The SN74AVC16T245 device can be used in level-shifting applications for interfacing devices and addressing mixed voltage incompatibility. The SN74AVC16T245 device is ideal for data transmission where direction is different for each channel.

10.1.1 Enable Times

Calculate the enable times for the SN74AVC16T45 using the following formulas:

| t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A) | (1) |
|--|-----|
| t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A) | (2) |
| t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B) | (3) |
| t_{PZI} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHI} (A to B) | (4) |

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC16T245 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

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10.2 Typical Application

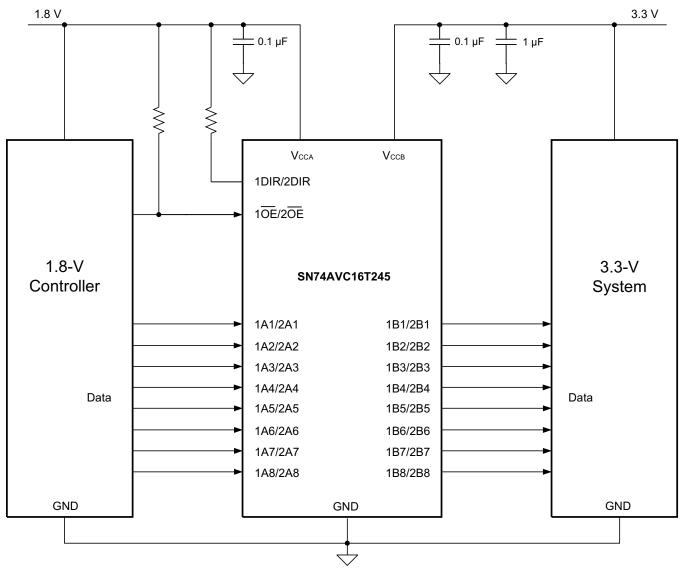


Figure 12. Typical Application Schematic

10.2.1 Design Requirements

This device uses drivers which are enabled depending on the state of the DIR pin. The designer must know the intended flow of data and take care not to violate any of the high or low logic levels. Unused data inputs must not be floating, as this can cause excessive internal leakage on the input CMOS structure. Tie any unused input and output ports directly to ground.

For this design example, use the parameters listed in Table 2.

| | g |
|----------------------|----------------|
| DESIGN PARAMETER | EXAMPLE VALUE |
| Input voltage range | 1.2 V to 3.6 V |
| Output voltage range | 1.2 V to 3.6 V |

Table 2. Design Parameters



10.2.2 Detailed Design Procedure

To begin the design process, determine the following:

10.2.2.1 Input Voltage Ranges

Use the supply voltage of the device that is driving the SN74AVC16T245 device to determine the input voltage range. For a valid logic high the value must exceed the V_{IH} of the input port. For a valid logic low the value must be less than the V_{IL} of the input port.

10.2.2.2 Output Voltage Range

Use the supply voltage of the device that the SN74AVC16T245 device is driving to determine the output voltage range.

10.2.3 Application Curve

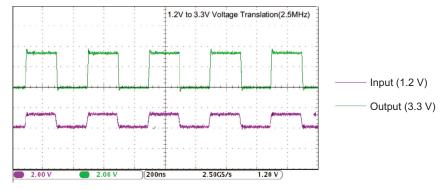


Figure 13. Translation Up (1.2 V to 3.3 V) at 2.5 MHz



11 Power Supply Recommendations

The SN74AVC16T245 device uses two separate configurable power-supply rails, V_{CCA} and V_{CCB}. VCCA accepts any supply voltage from 1.2 V to 3.6 V and V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. The A port and B port are designed to track V_{CCA} and V_{CCB}, respectively, allowing for low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V and 3.3-V voltage nodes.

The output-enable \overline{OE} input circuit is designed so that it is supplied by V_{CCA} and when the \overline{OE} input is high, all outputs are placed in the high-impedance state. To ensure the high-impedance state of the outputs during power up or power down, the \overline{OE} input pin must be tied to V_{CCA} through a pullup resistor and must not be enabled until V_{CCA} and V_{CCB} are fully ramped and stable. The minimum value of the pullup resistor to V_{CCA} is determined by the current-sinking capability of the driver.

12 Layout

12.1 Layout Guidelines

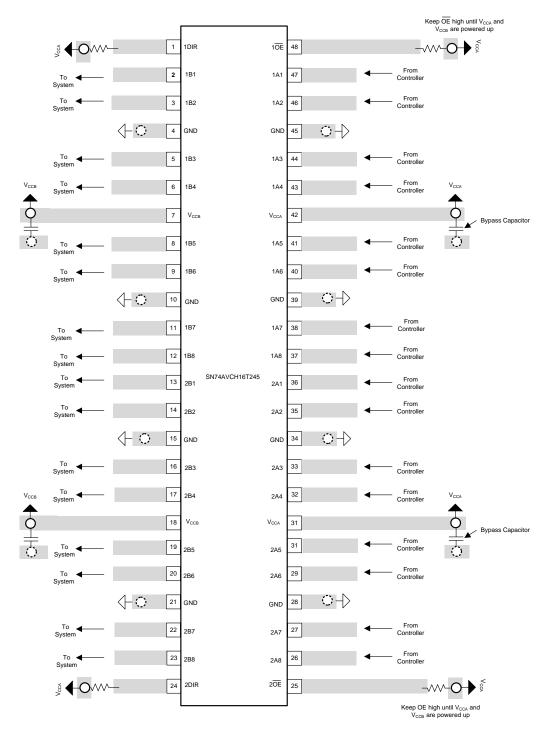
To ensure reliability of the device, following common printed-circuit-board layout guidelines is recommended.

- · Bypass capacitors should be used on power supplies.
- · Short trace lengths should be used to avoid excessive loading.
- Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements.



12.2 Layout Example







TEXAS INSTRUMENTS

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13 Device and Documentation Support

13.1 Documentation Support

13.1.1 Related Documentation

For related documentation see the following:

- CMOS Power Consumption and Cpd Calculation, SCAA035
- Implications of Slow or Floating CMOS Inputs, SCBA004

13.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E[™] Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

13.3 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

13.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

13.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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6-Feb-2020

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|-------------------|---------------|----------------------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|-------------------------|---------|
| 74AVC16T245DGGRE4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVC16T245 | Samples |
| 74AVC16T245DGVRE4 | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WF245 | Samples |
| AVC16T245DGGR-D | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVC16T245 | Samples |
| SN74AVC16T245DGG | ACTIVE | TSSOP | DGG | 48 | 40 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVC16T245 | Samples |
| SN74AVC16T245DGGR | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVC16T245 | Samples |
| SN74AVC16T245DGVR | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WF245 | Samples |
| SN74AVC16T245ZQLR | LIFEBUY | BGA MICROSTAR JUNIOR | ZQL | 56 | 1000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | WF245 | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



PACKAGE OPTION ADDENDUM

6-Feb-2020

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN74AVC16T245 :

Automotive: SN74AVC16T245-Q1

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

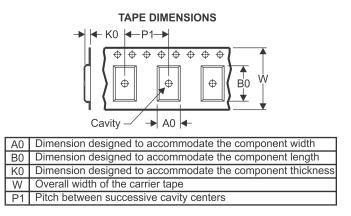
PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|----------------------------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AVC16T245DGGR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AVC16T245DGVR | TVSOP | DGV | 48 | 2000 | 330.0 | 16.4 | 7.1 | 10.2 | 1.6 | 12.0 | 16.0 | Q1 |
| SN74AVC16T245ZQLR | BGA MI CROSTA R JUNI OR | ZQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.5 | 8.0 | 16.0 | Q1 |

TEXAS INSTRUMENTS

www.ti.com

PACKAGE MATERIALS INFORMATION

12-Feb-2019



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|-------------------------|-----------------|------|------|-------------|------------|-------------|
| SN74AVC16T245DGGR | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |
| SN74AVC16T245DGVR | TVSOP | DGV | 48 | 2000 | 367.0 | 367.0 | 38.0 |
| SN74AVC16T245ZQLR | BGA MICROSTAR JUNIOR | ZQL | 56 | 1000 | 350.0 | 350.0 | 43.0 |

MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



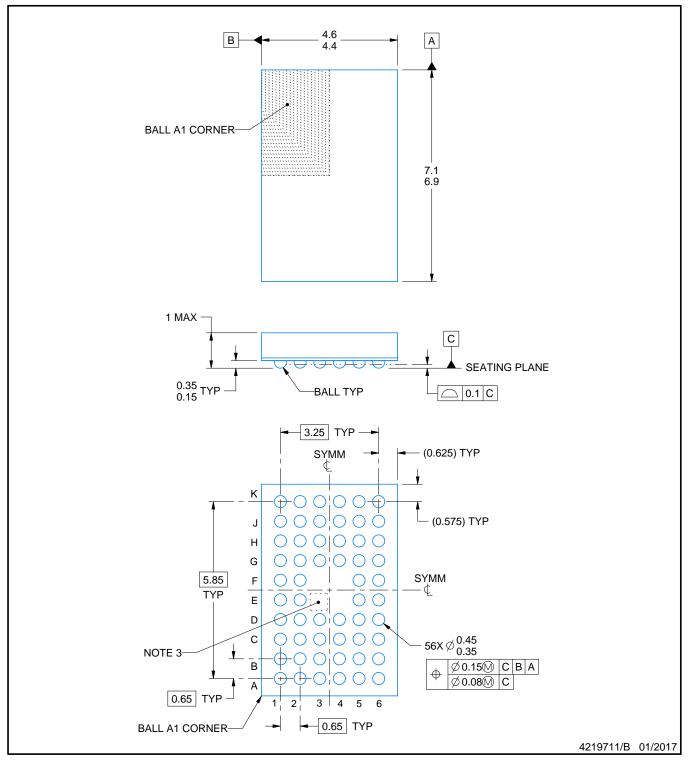
ZQL0056A



PACKAGE OUTLINE

JRBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- 3. No metal in this area, indicates orientation.

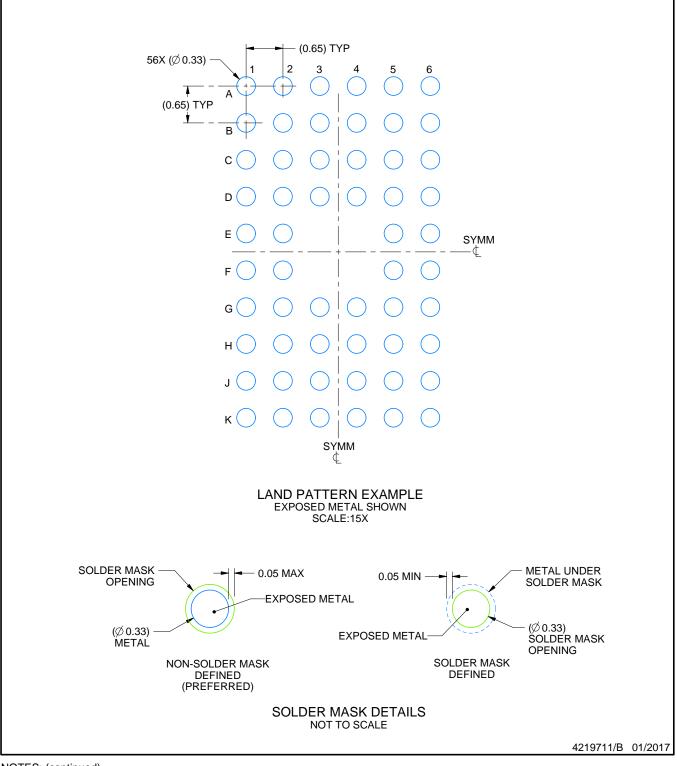


ZQL0056A

EXAMPLE BOARD LAYOUT

JRBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For information, see Texas Instruments literature number SPRAA99 (www.ti.com/lit/spraa99).

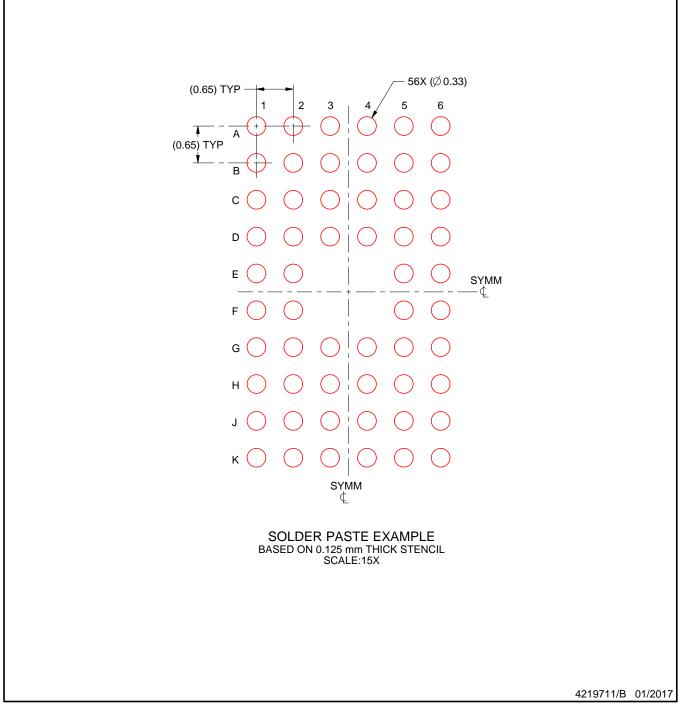


ZQL0056A

EXAMPLE STENCIL DESIGN

JRBGA - 1 mm max height

PLASTIC BALL GRID ARRAY



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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